

MOSFET

OptiMOS[™] 6 Power-Transistor, 120 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature

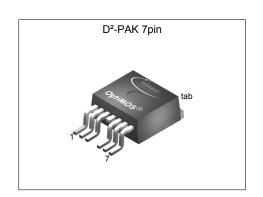
- Optimized for high frequency switching
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

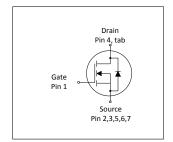
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

<u> </u>								
Parameter	Value	Unit						
V _{DS}	120	V						
R _{DS(on),max}	1.9	mΩ						
I _D	254	A						
Qoss	267	nC						
Q _G	113	nC						
Q _{rr} (1000 A/µs)	336	nC						











Type / Ordering Code	Package	Marking	Related Links
IPF019N12NM6	PG-TO263-7	019N12N6	-

OptiMOS[™] 6 Power-Transistor, 120 V IPF019N12NM6



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OptiMOS[™] 6 Power-Transistor, 120 V **IPF019N12NM6**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	0		Value	S		Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit		
Continuous drain current ¹⁾	I _D	- - -	- - -	254 195 195 31	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =8 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =40°C/W ²)	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1016	Α	<i>T</i> _A =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	100	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	1406	mJ	$I_{\rm D}$ =73 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	395 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Devementes	Cumbal	Values			11	Nata / Tank Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.38	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)		-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.
²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information.

4) See Diagram 13 for more detailed information.

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	120	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.6	3.1	3.6	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =275 μ A	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.7 1.9	1.9 2.23	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =8 V, I _D =50 A	
Gate resistance	R _G	0.55	1.09	1.64	Ω	-	
Transconductance	g fs	100	200	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$	

Table 5 Dynamic characteristics

Davamatav	Cymphal	Values			11!4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C _{iss}	-	8100	11000	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	2400	3100	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	40	70	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	21	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	19	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	38	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	19	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge ¹⁾	Q _{gs}	-	40	52	nC	V _{DD} =60 V, I _D =50 A, V _{GS} =0 to 10 V	
Gate charge at threshold ¹⁾	Q _{g(th)}	-	25	31	nC	$V_{\rm DD}$ =60 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	Q _{gd}	-	24	36	nC	V _{DD} =60 V, I _D =50 A, V _{GS} =0 to 10 V	
Switching charge	Q _{sw}	-	42	-	nC	V _{DD} =60 V, I _D =50 A, V _{GS} =0 to 10 V	
Gate charge total ¹⁾	Q g	-	113	141	nC	V _{DD} =60 V, I _D =50 A, V _{GS} =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.9	-	V	V _{DD} =60 V, I _D =50 A, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	267	334	nC	V _{DS} =60 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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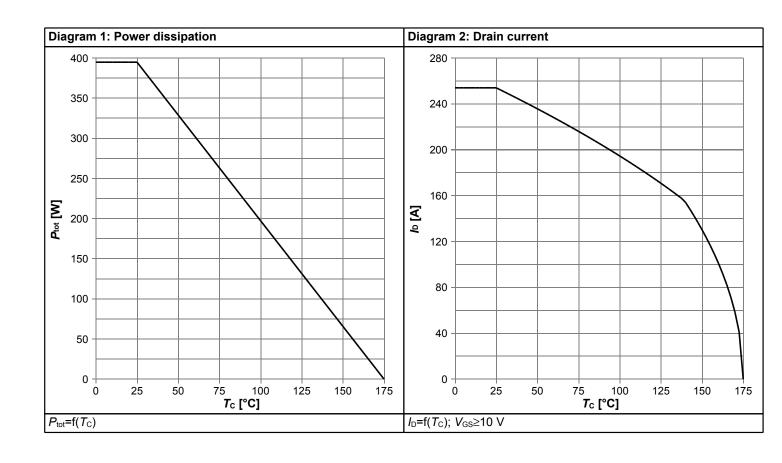


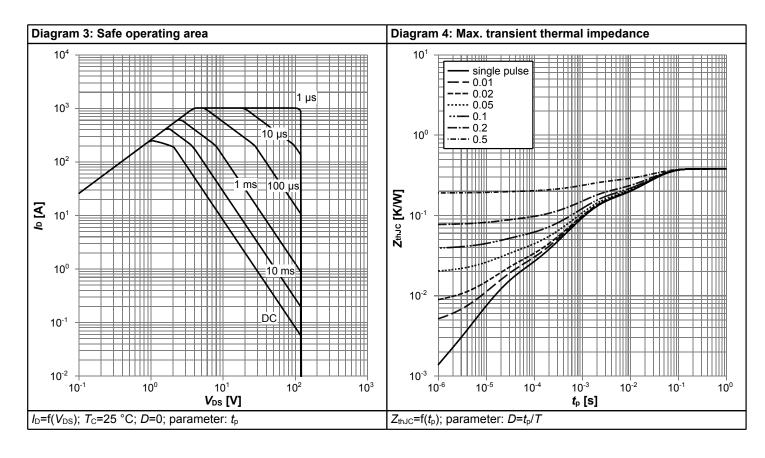
Table 7 Reverse diode

Davamatav	Comple ed		Values			Nata / Tant Canadition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	223	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1016	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.85	1.0	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	43	86	ns	V _R =60 V, I _F =50 A, di _F /dt=300 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	125	250	nC	V _R =60 V, I _F =50 A, di _F /dt=300 A/μs	
Reverse recovery time ¹⁾	t _{rr}	-	35	70	ns	V_R =60 V, I_F =50 A, di_F/dt =1000 A/ μ s	
Reverse recovery charge ¹⁾	Qrr	-	336	672	nC	V_R =60 V, I_F =50 A, di_F/dt =1000 A/ μ s	

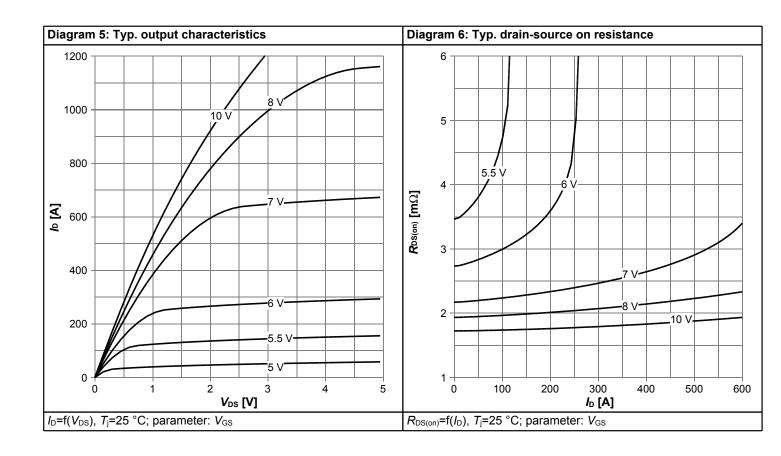


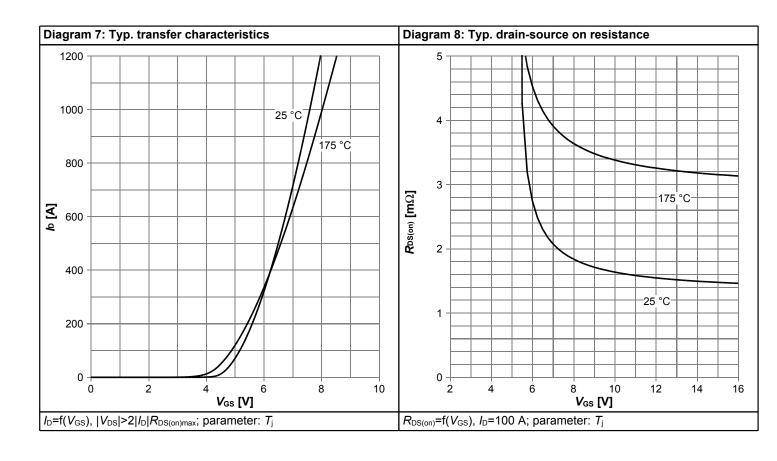
4 Electrical characteristics diagrams



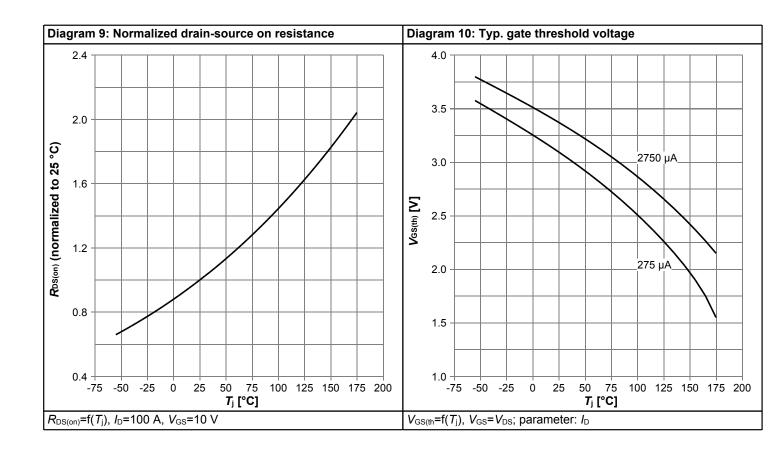


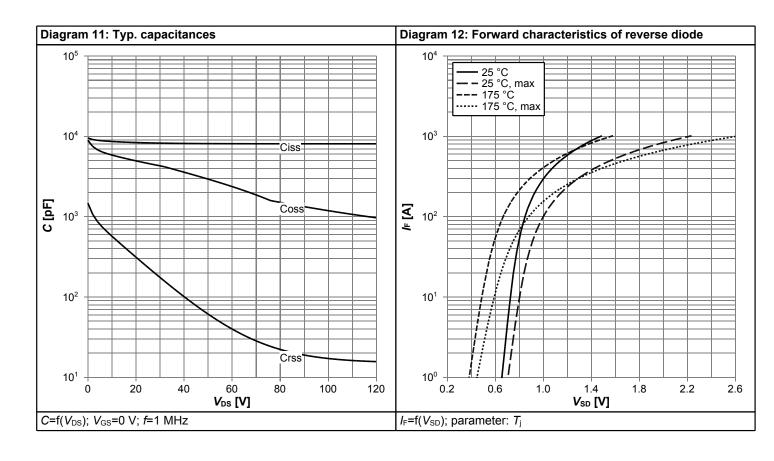




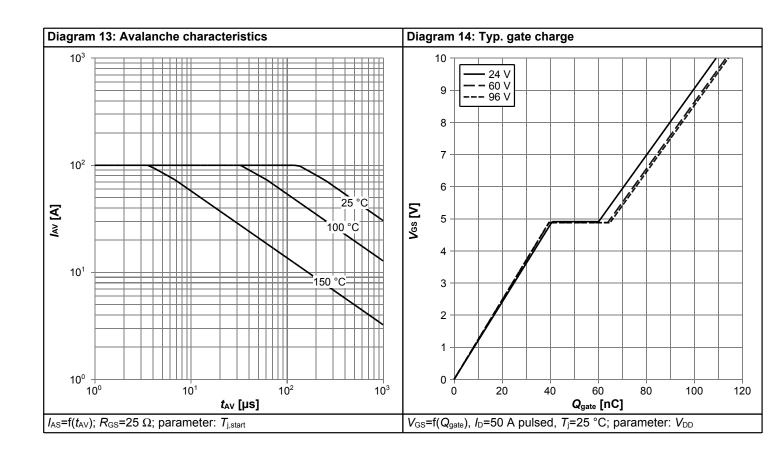


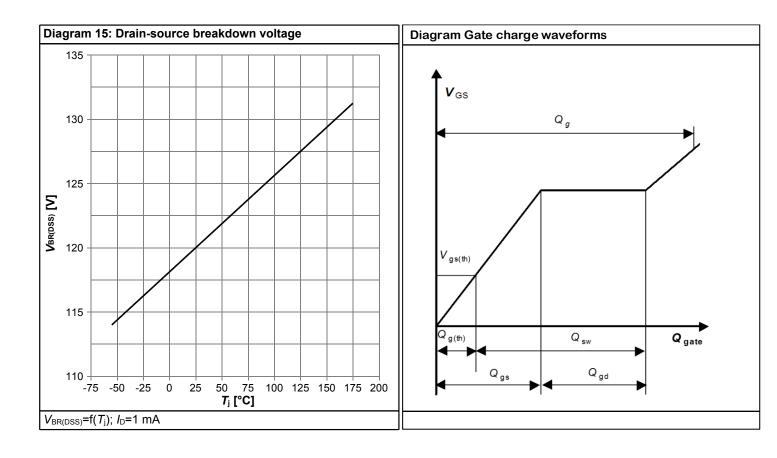






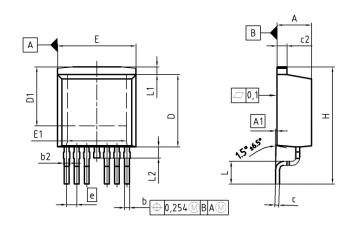


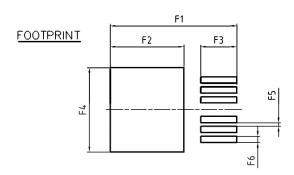






5 Package Outlines





DIM	MILLIM	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	0.00	0.25	0.000	0.010	
Ь	0.50	0.70	0.020	0.028	
b2	0.50	1.00	0.020	0.039	
С	0.33	0.65	0.013	0.026	
c2	1.17	1.40	0.046	0.055	
D	8.51	9.45	0.335	0.372	
D1	6.90	7.90	0.272	0.311	
E	9.80	10.31	0.386	0.406	
E1	6.50	8.60	0.256	0.339	
е	1.	27	0.050		
N		6		6	
Н	14.61	15.88	0.575	0.625	
L	2.29	3.00	0.090	0.118	
L1	0.70	1.60	0.028	0.063	
L2	1.00	1.78	0.039	0.070	
F1	16.05	16.25	0.632	0.640	
F2	9,30	9.50	0.366	0.374	
F3	4.50	4.70	0.177	0.185	
F4	10.70	10.90	0.421	0.429	
F5	0.37	0.57	0.015	0.022	
F6	0.70	0.90	0.028	0.035	

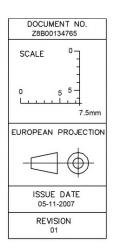


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

OptiMOSTM 6 Power-Transistor, 120 V



Revision History

IPF019N12NM6

Revision: 2023-02-03, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2023-02-03	Release of final version				

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